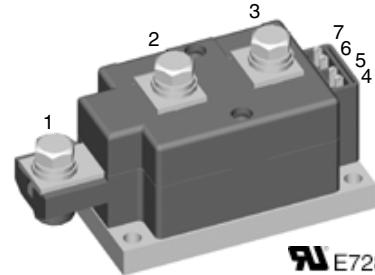
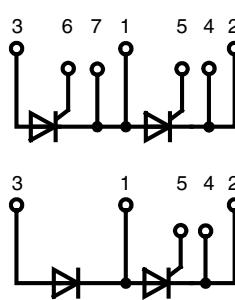


Thyristor Modules

Thyristor/Diode Modules

$I_{TRMS} = 2 \times 400 \text{ A}$
 $I_{TAVM} = 2 \times 240 \text{ A}$
 $V_{RRM} = 2000/2200 \text{ V}$

V_{RSM}	V_{RRM}	Type
V_{DSM}	V_{DRM}	
V	V	
2100	2000	MCC 224-20io1
2300	2200	MCC 224-22io1
		MCD 224-20io1
		MCD 224-22io1



E72873

Symbol	Conditions	Maximum Ratings		
I_{TRMS}	$T_{VJ} = T_{VJM}$	400	A	
I_{TAVM}	$T_c = 85^\circ\text{C}$; 180° sine	240	A	
I_{TSM}	$T_{VJ} = 45^\circ\text{C}$; $t = 10 \text{ ms}$ (50 Hz) $V_R = 0$ $t = 8.3 \text{ ms}$ (60 Hz)	8000	A	
		8500	A	
	$T_{VJ} = T_{VJM}$; $V_R = 0$ $t = 10 \text{ ms}$ (50 Hz) $t = 8.3 \text{ ms}$ (60 Hz)	7000	A	
		7500	A	
I^2t	$T_{VJ} = 45^\circ\text{C}$; $t = 10 \text{ ms}$ (50 Hz) $V_R = 0$ $t = 8.3 \text{ ms}$ (60 Hz)	320 000	A ² s	
		303 000	A ² s	
	$T_{VJ} = T_{VJM}$; $V_R = 0$ $t = 10 \text{ ms}$ (50 Hz) $t = 8.3 \text{ ms}$ (60 Hz)	245 000	A ² s	
		240 000	A ² s	
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}$; repetitive, $I_T = 750 \text{ A}$ $f = 50 \text{ Hz}$; $t_p = 200 \mu\text{s}$	100	A/ μs	
	$V_D = \frac{2}{3} V_{DRM}$; $I_G = 1 \text{ A}$; non repetitive, $I_T = I_{TAVM}$ $di_G/dt = 1 \text{ A}/\mu\text{s}$	500	A/ μs	
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}$; $V_D = \frac{2}{3} V_{DRM}$; $R_{GK} = \infty$; method 1 (linear voltage rise)	1000	V/ μs	
P_{GM}	$T_{VJ} = T_{VJM}$; $t_p = 30 \mu\text{s}$ $I_T = I_{TAVM}$; $t_p = 500 \mu\text{s}$	120	W	
		60	W	
P_{GAV}		20	W	
V_{RGM}		10	V	
T_{VJ}		-40...+130	°C	
T_{VJM}		130	°C	
T_{stg}		-40...+125	°C	
V_{ISOL}	50/60 Hz, RMS $t = 1 \text{ min}$ $I_{ISOL} \leq 1 \text{ mA}$ $t = 1 \text{ s}$	3000	V~	
		3600	V~	
M_d	Mounting torque (M6) Terminal connection torque (M6)	4.5 - 7	Nm	
		11 - 13	Nm	
Weight	Typical including screws	750	g	

Data according to IEC 60747 and refer to a single diode unless otherwise stated.

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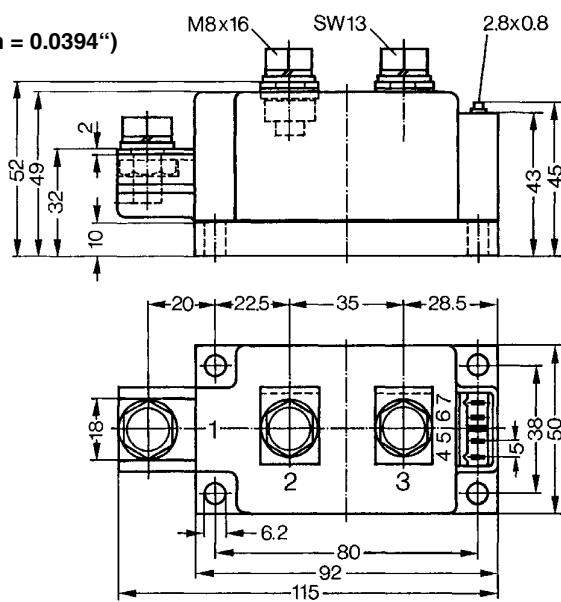
Symbol	Conditions	Characteristic Values	
		typ.	max.
I_{RRM}, I_{DRM}	$V_R / V_D = V_{RRM} / V_{DRM}$	$T_{VJ} = T_{VJM}$	40 mA
V_T	$I_T = 600 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$	1.4 V
V_{TO}	For power-loss calculations only		0.8 V
r_t		$T_{VJ} = T_{VJM}$	0.76 mΩ
V_{GT}	$V_D = 6 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	2 V
		$T_{VJ} = -40^\circ\text{C}$	3 V
I_{GT}	$V_D = 6 \text{ V}$	$T_{VJ} = 25^\circ\text{C}$	150 mA
		$T_{VJ} = -40^\circ\text{C}$	220 mA
V_{GD}	$V_D = \frac{2}{3} V_{DRM}$	$T_{VJ} = T_{VJM}$	0.25 V
I_{GD}			10 mA
I_L	$t_p = 30 \mu\text{s}; V_D = 6 \text{ V}$ $I_G = 0.45 \text{ A}; di_G/dt = 0.45 \text{ A}/\mu\text{s}$	$T_{VJ} = 25^\circ\text{C}$	200 mA
I_H	$V_D = 6 \text{ V}; R_{GK} = \infty$	$T_{VJ} = 25^\circ\text{C}$	150 mA
t_{gd}	$V_D = \frac{1}{2} V_{DRM}$ $I_G = 1 \text{ A}; di_G/dt = 1 \text{ A}/\mu\text{s}$	$T_{VJ} = 25^\circ\text{C}$	2 μs
t_q	$V_D = \frac{2}{3} V_{DRM}$ $dv/dt = 50 \text{ V}/\mu\text{s}; -di/dt = 10 \text{ A}/\mu\text{s}$ $I_T = 300 \text{ A}; V_R = 100 \text{ V}; t_p = 200 \mu\text{s}$	$T_{VJ} = T_{VJM}$	200 μs
Q_s	$I_T = 300 \text{ A}; -di/dt = 50 \text{ A}/\mu\text{s}$	$T_{VJ} = T_{VJM}$	760 μC
I_{RM}			275 A
R_{thJC}	per thyristor; DC current		0.139 K/W
	per module		0.069 K/W
R_{thJK}	per thyristor; DC current		0.179 K/W
	per module		0.089 K/W
d_s	Creeping distance on surface		12.7 mm
d_A	Creepage distance in air		9.6 mm
a	Maximum allowable acceleration		50 m/s ²

Optional accessories for modules

Keyed gate/cathode twin plugs with wire length = 350 mm, gate = yellow, cathode = red

Type **ZY 180L** (L = Left for pin pair 4/5) UL 758, style 1385,
Type **ZY 180R** (R = right for pin pair 6/7) CSA class 5851, guide 460-1-1

Dimensions in mm (1 mm = 0.0394")



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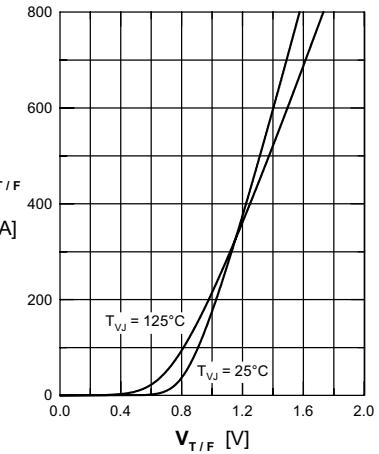


Fig. 1 Forward characteristics

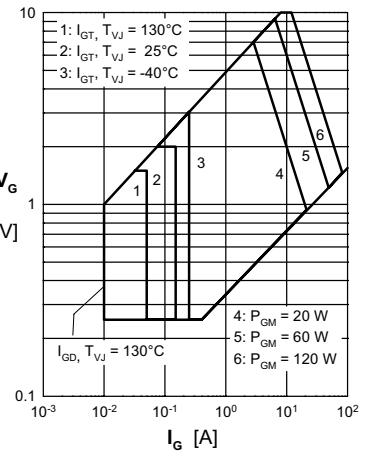


Fig. 2 Gate trigger characteristics

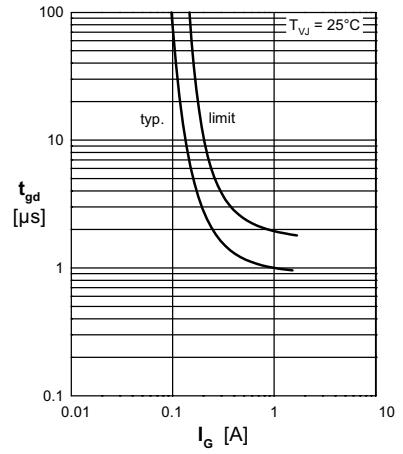
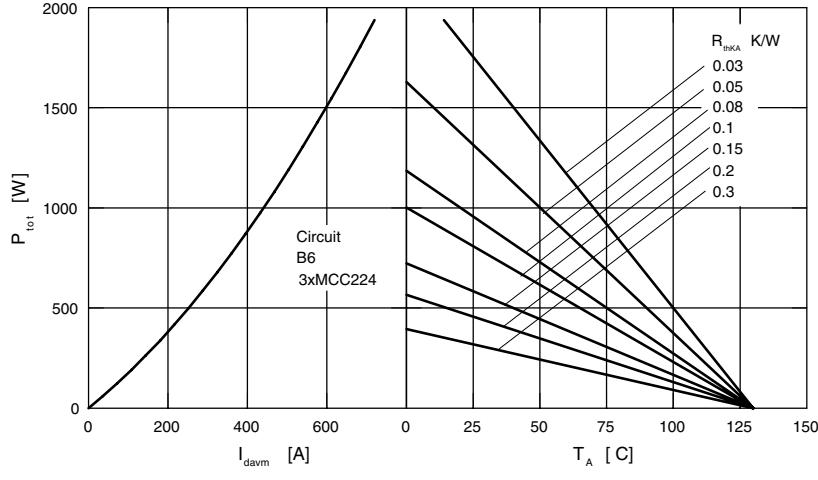
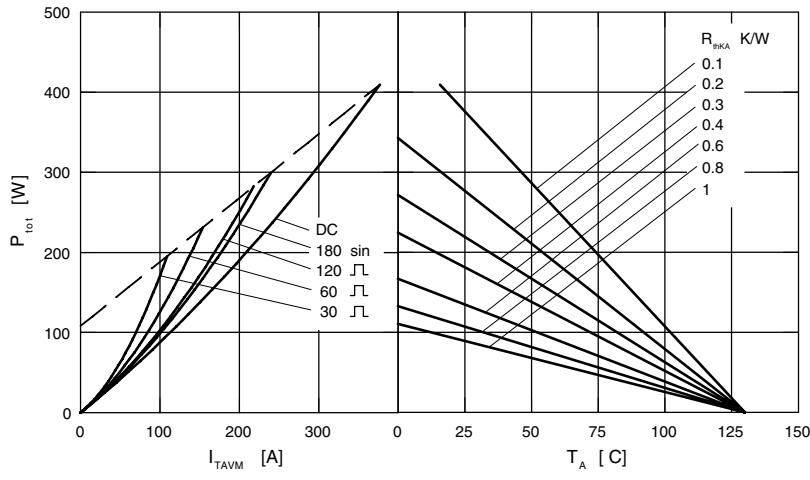
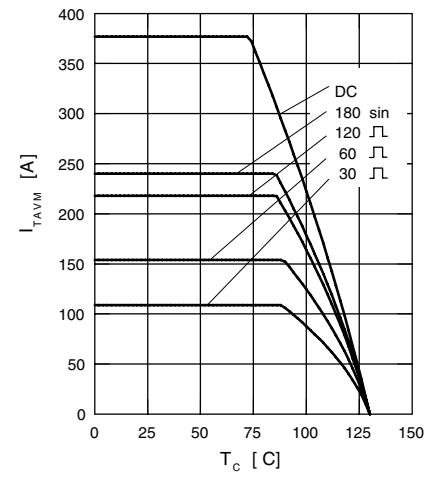
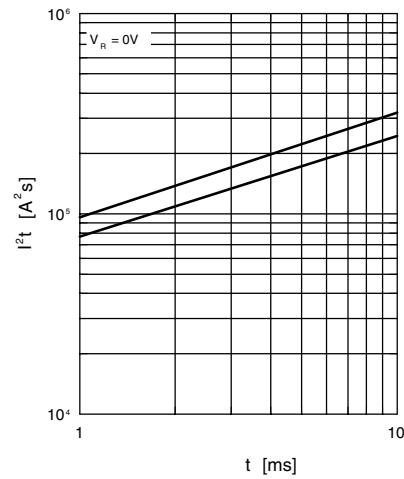
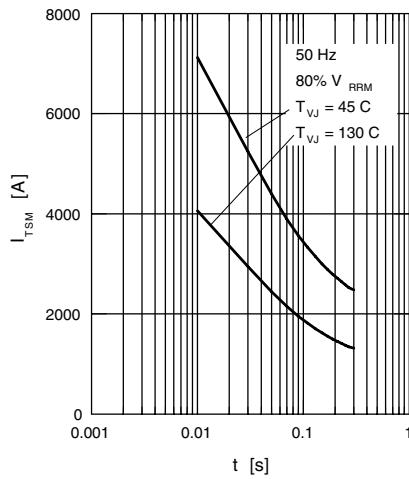


Fig. 3 Gate trigger delay time



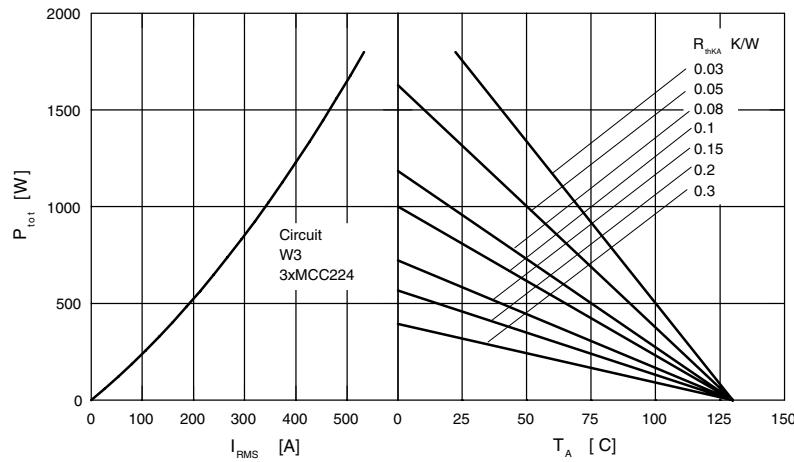


Fig. 8 3~ AC-controller: Power dissipation vs. RMS output current & ambient temperature

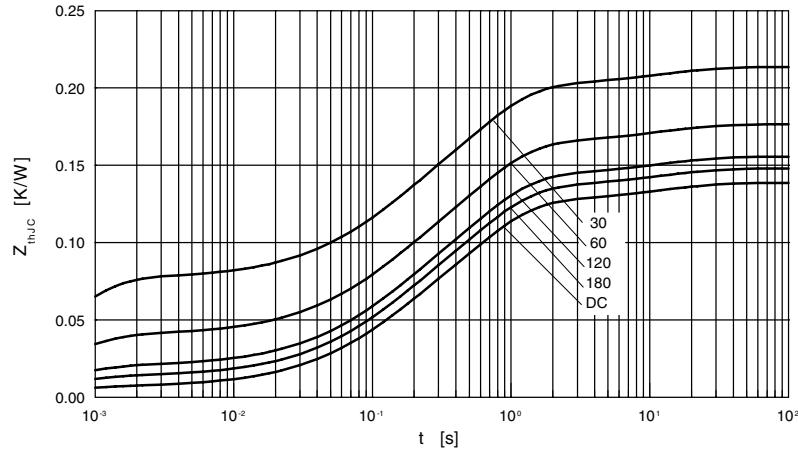


Fig. 9 Transient thermal impedance junction to case

R_{thJC} for various conduction angles d:

d	R_{thJC} (K/W)
DC	0.139
180°	0.148
120°	0.156
60°	0.176
30°	0.214

Constants for Z_{thJC} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0067	0.00054
2	0.0358	0.098
3	0.0832	0.54
4	0.0129	12

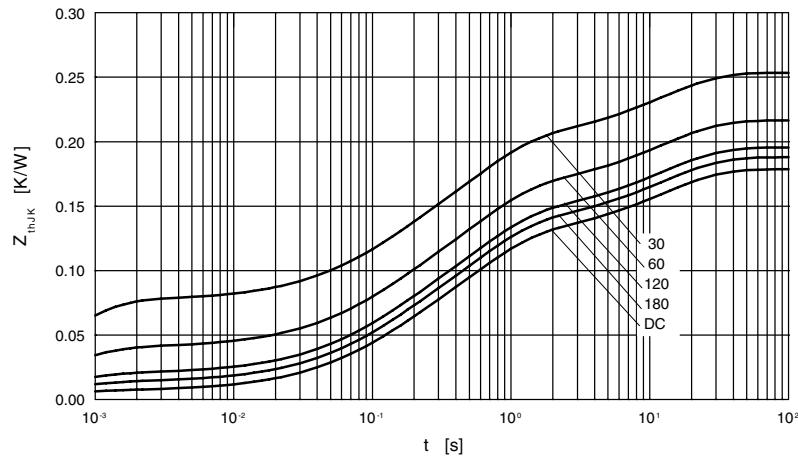


Fig. 10 Transient thermal impedance junction to heatsink

R_{thJK} for various conduction angles d:

d	R_{thJK} (K/W)
DC	0.179
180°	0.188
120°	0.196
60°	0.216
30°	0.256

Constants for Z_{thJK} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0067	0.001
2	0.0358	0.08
3	0.0832	0.20
4	0.0129	1.0
5	0.04	